KEMET Part Number: C0805X333K1RAC



SMD Comm X7R Flex, Ceramic, 0.033 uF, 10%, 100 VDC, X7R, SMD, MLCC, FT-CAP, Temperature Stable, 0805



Dimensions		
Chip Size	0805	
L	2mm +/-0.3mm	
W	1.25mm +/-0.3mm	
Т	0.9mm +/-0.10mm	
S	0.75mm MIN	
В	0.5mm +/-0.25mm	

Packaging Specifications		
Packaging:	Bulk, Bag	
Packaging Quantity:	1	

General Information		
Series:	SMD Comm X7R Flex	
Style:	SMD Chip	
Description:	SMD, MLCC, FT-CAP, Temperature Stable	
Features:	FT-CAP, Temperature Stable	
RoHS:	Yes	
Termination:	Flexible Termination	
Marking:	No	
AEC-Q200:	No	
Component Weight:	13 mg	
Shelf Life:	78 Weeks	
MSL:	1	

Specifications		
Capacitance:	0.033 uF	
Measurement Condition:	1 kHz 1.0Vrms	
Capacitance Tolerance:	10%	
Voltage DC:	100 VDC	
Dielectric Withstanding Voltage:	250 VDC	
Temperature Range:	-55/+125°C	
Temperature Coefficient:	X7R	
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	15%, 1kHz 1.0Vrms	
Dissipation Factor:	2.5% 1 kHz 1.0Vrms	
Aging Rate:	3% Loss/Decade Hour: Referee Time is 1000 Hours	
Insulation Resistance:	30.303 GOhms	

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.



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